

Description

The PAM8304 is a mono, filter-less, Class-D amplifier with high SNR (signal-to-noise ratio) and differential input that helps eliminate noise. The PAM8304 supports 2.8V to 6V operation, which makes it ideal for up to 4-cell alkaline battery applications. The PAM8304 is capable of driving speaker loads as low as 3Ω with a 5V supply, maximizing the output power.

The device's over 90% efficiency and small PCB area make the PAM8304 Class-D amplifier ideal for portable applications. The output uses a filter-less architecture, minimizing the number of external components in the PCB area whilst providing a high-performance, simple, and lower cost system.

The PAM8304 features short-circuit protection, thermal shutdown, and undervoltage lockout.

The PAM8304 is available in the U-DFN3030-8 (Type E) and MSOP-8 packages.

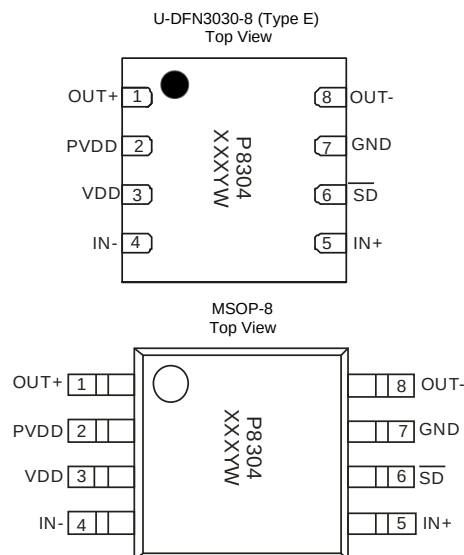
Features

- Supply Voltage from 2.8V to 6.0V
- 3Ω Driving Capability
- 3.0W@10% THD Output with a 4Ω Load and 5V Supply
- High Efficiency Up to 90% @1W with an 8Ω Load
- Shutdown Current < 1μA
- Superior Low Noise Without Input
- Short-Circuit Protection
- Thermal Shutdown
- Available in Space-Saving U-DFN3030-8 (Type E) and MSOP-8 Packages
- Pb-Free Package
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](https://www.diodes.com/quality/product-definitions/) or your local Diodes representative.**

<https://www.diodes.com/quality/product-definitions/>

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

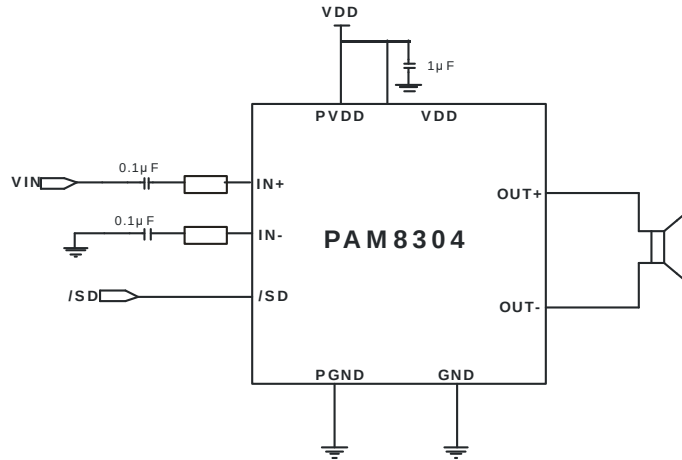
Pin Assignments



Applications

- MP4/MP3
- GPS
- Set-top-boxes
- Tablets/digital photo frames
- Electronic dictionaries
- Portable game machines

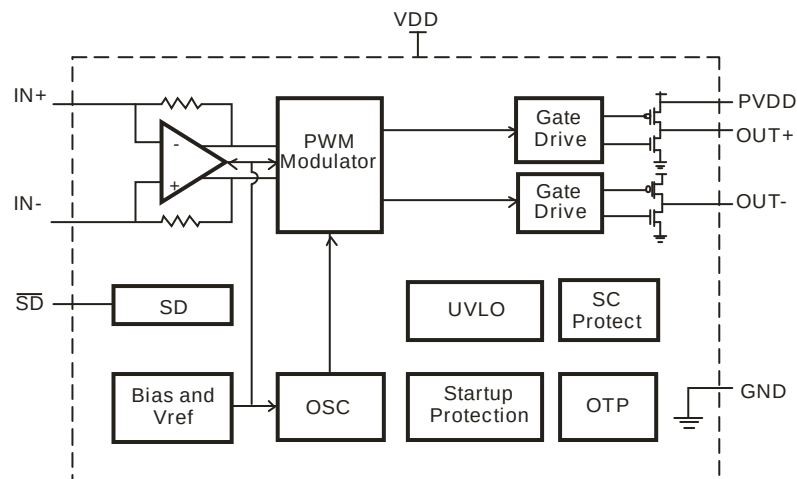
Typical Applications Circuit



Pin Descriptions

Pin Name	MSOP-8 / U-DFN3030-8 (Type E)	Function
OUT+	1	Positive BTL Output
PVDD	2	Power Supply
VDD	3	Analog Power Supply
IN-	4	Negative Differential Input
IN+	5	Positive Differential Input
/SD	6	Shutdown Terminal, Active Low
GND	7	Ground
OUT-	8	Negative BTL Output
Exposed Pad	—	NC

Functional Block Diagram



Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Parameter	Rating	Unit
Supply Voltage (V _{DD})	6.5	V
Input Voltage (IN+, IN-, /SD)	-0.3 to V _{DD} + 0.3	V
Storage Temperature	-65 to +150	°C
Maximum Junction Temperature	+150	°C

Recommended Operating Conditions (@T_A = +25°C, unless otherwise specified.)

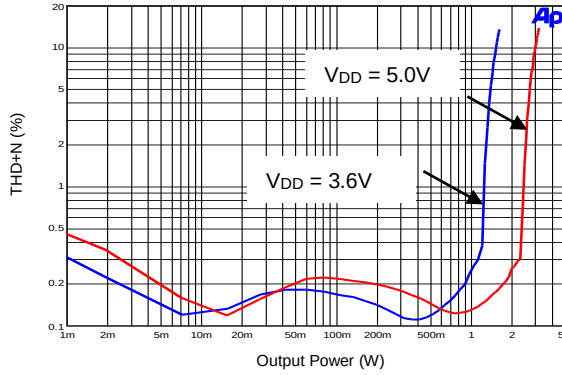
Symbol	Parameter	Min	Max	Unit
V _{DD}	Supply Voltage	2.8	6.0	V
T _A	Operating Ambient Temperature Range	-40	+85	°C
T _J	Junction Temperature Range	-40	+125	°C

Electrical Characteristics (@T_A = +25°C, V_{DD} = 5V, Gain = 18dB, R_L = L(33μH) + R + L(33μH), unless otherwise specified.)

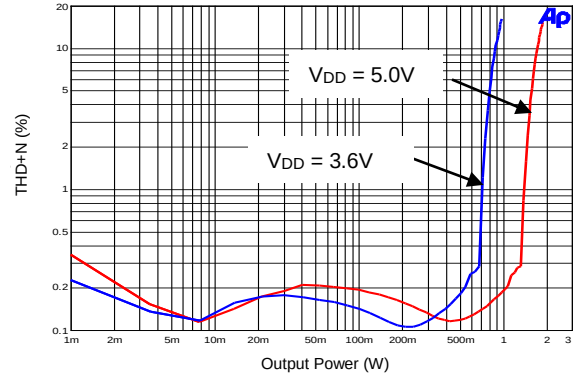
Symbol	Parameter	Test Conditions		Min	Typ	Max	Unit
V _{DD}	Supply Voltage	—		2.8	—	6.0	V
P _O	Output Power	THD+N = 10%, f = 1kHz, R = 4Ω	V _{DD} = 5.0V	—	3.0	—	W
			V _{DD} = 3.6V	—	1.5	—	
			V _{DD} = 3.2V	—	1.2	—	
		THD+N = 1%, f = 1kHz, R = 4Ω	V _{DD} = 5.0V	—	2.4	—	W
			V _{DD} = 3.6V	—	1.25	—	
			V _{DD} = 3.2V	—	1.0	—	
		THD+N = 10%, f = 1kHz, R = 8Ω	V _{DD} = 5.0V	—	1.75	—	W
			V _{DD} = 3.6V	—	0.90	—	
			V _{DD} = 3.2V	—	0.70	—	
		THD+N = 1%, f = 1kHz, R = 8Ω	V _{DD} = 5.0V	—	1.40	—	W
			V _{DD} = 3.6V	—	0.72	—	
			V _{DD} = 3.2V	—	0.60	—	
THD+N	Total Harmonic Distortion Plus Noise	V _{DD} = 5.0V, P _O = 1W, R = 8Ω	f = 1kHz	—	0.17	—	%
		V _{DD} = 3.6V, P _O = 0.1W, R = 8Ω		—	0.16	—	
		V _{DD} = 3.2V, P _O = 0.1W, R = 8Ω		—	0.14	—	
		V _{DD} = 5.0V, P _O = 0.5W, R = 4Ω	f = 1kHz	—	0.14	—	%
		V _{DD} = 3.6V, P _O = 0.2W, R = 4Ω		—	0.16	—	
		V _{DD} = 3.2V, P _O = 0.1W, R = 4Ω		—	0.17	—	
PSRR	Power-Supply Ripple Rejection	V _{DD} = 3.6V, Inputs AC-Grounded with C = 1μF	f = 217Hz	—	-68	—	dB
			f = 1kHz	—	-70	—	
			f = 10kHz	—	-67	—	
Dyn	Dynamic Range	V _{DD} = 5V, THD = 1%, R = 8Ω	f = 1kHz	—	95	—	dB
V _N	Output Noise	Inputs AC-Grounded	No A-Weighting	—	170	—	μV
			A-Weighting	—	130	—	
η	Efficiency	R _L = 8Ω, THD = 10%	f = 1kHz	—	93	—	%
		R _L = 4Ω, THD = 10%		—	86	—	
I _Q	Quiescent Current	V _{DD} = 5V	No Load	—	5	—	mA
I _{SD}	Shutdown Current	V _{DD} = 2.8V to 5V	/SD=0V	—	—	1	μA
R _{DS(ON)}	Static Drain-to Source On-State Resistor	High-Side pMOS, I = 500mA	V _{DD} = 5.0V	—	325	—	mΩ
		Low-Side nMOS, I = 500mA	V _{DD} = 5.0V	—	200	—	mΩ
f _{SW}	Switching Frequency	V _{DD} = 2.8V to 5V	—	—	400	—	kHz
G _V	Closed-Loop Gain	V _{DD} = 2.8V to 5V	—	—	300K/R _{in}	—	V/V
V _{OS}	Output Offset Voltage	Input AC-Grounded, V _{DD} = 5V	—	—	—	50	mV
V _{IH}	SD Input High Voltage	V _{DD} = 5V	—	1.4	—	—	V
V _{IL}	SD Input Low Voltage	V _{DD} = 5V	—	—	—	0.4	

Performance Characteristics (@ $T_A = +25^\circ\text{C}$, $V_{DD} = 5\text{V}$, Gain = 18dB, $R_L = L(33\mu\text{H}) + R + L(33\mu\text{H})$, unless otherwise specified.)

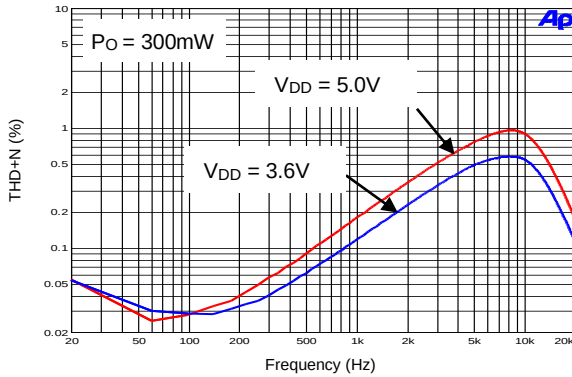
THD+N vs. Output Power ($R_L = 4\Omega$)



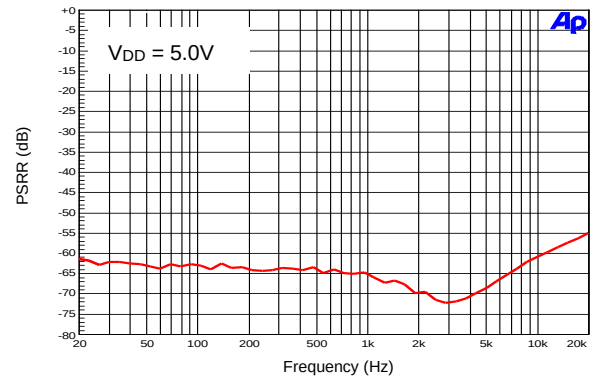
THD+N vs. Output Power ($R_L = 8\Omega$)



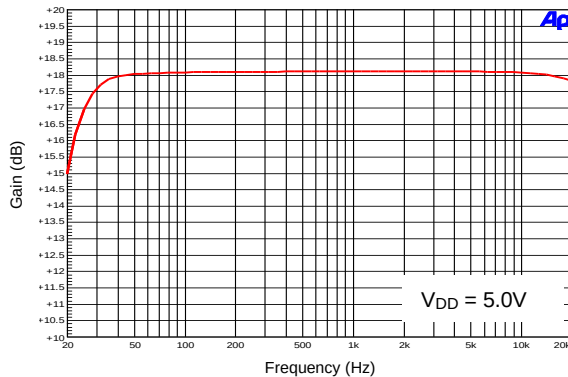
THD+N vs. Frequency



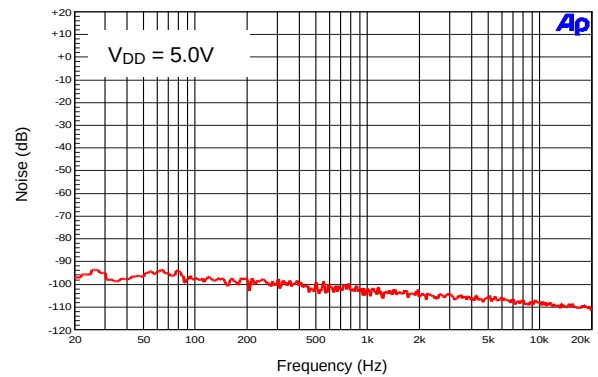
PSRR vs. Frequency



Frequency Response

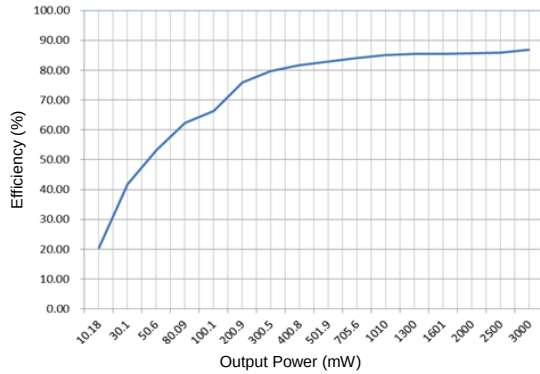


Noise Floor

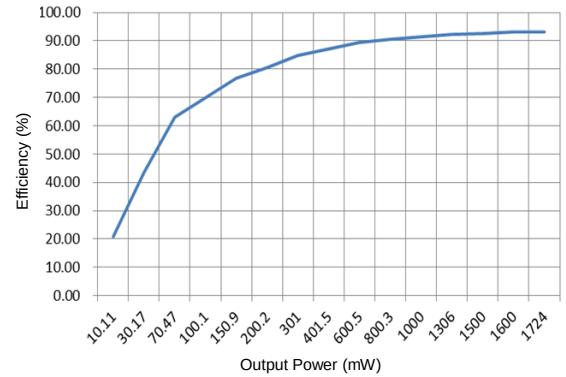


Performance Characteristics (@T_A = +25°C, V_{DD} = 5V, Gain = 18dB, R_L = L(33μH) + R + L(33μH), unless otherwise specified.)
(continued)

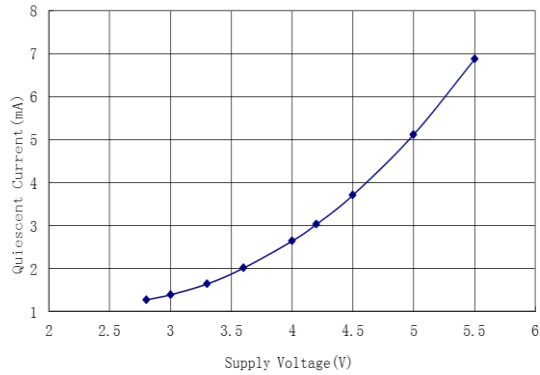
Efficiency vs. Output Power (R_L = 4Ω)



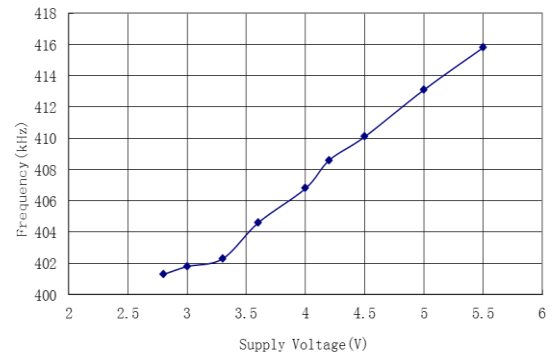
Efficiency vs. Output Power (R_L = 8Ω)



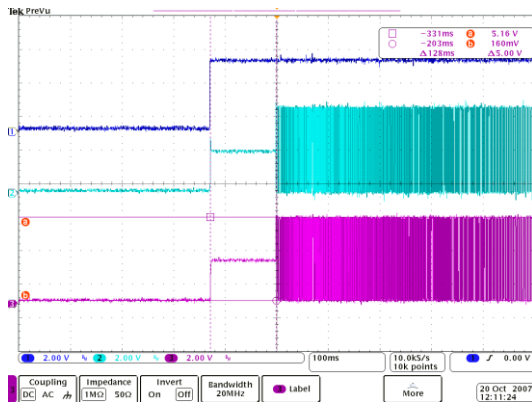
Quiescent Current vs. Supply Voltage



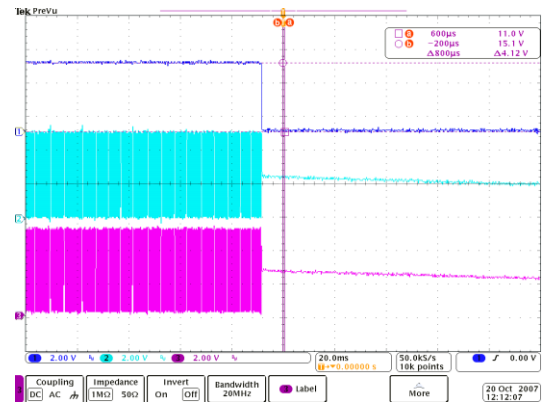
OSC Frequency vs. Supply Voltage



Startup Response



Shutdown Response



Application Information

Input Capacitors (Ci)

In a typical application, an input capacitor C_i is required to allow the amplifier to bias the input signal to the proper DC level for optimum operation. In this case, C_i and the minimum input impedance R_i form a high-pass filter with the corner frequency determined in the following equation:

$$f_c = \frac{1}{(2\pi R_i C_i)}$$

It is important to consider the value of C_i as it directly affects the low-frequency performance of the circuit. For example, when R_i is 150k Ω and the specification calls for a flat bass response down to 150Hz. The equation is reconfigured as follow to determine the value of C_i :

$$C_i = \frac{1}{(2\pi R_i f_c)}$$

When input resistance variation is considered, if C_i is 7nF, one would likely choose a value of 10nF. A further consideration for this capacitor is the leakage path from the input source through the input network (C_i , R_i , and R_f) to the load. This leakage current creates a DC offset voltage at the input to the amplifier and reduces useful headroom, especially in high-gain applications. For this reason, a low-leakage tantalum or ceramic capacitor is recommended. When polarized capacitors are used, the positive side of the capacitor should face the amplifier input in most applications as the DC level is held at $V_{DD}/2$, which is likely higher than the source DC level. Please note that it is important to confirm the capacitor polarity in the application.

Decoupling Capacitor (CS)

The PAM8304 is a high-performance CMOS audio amplifier that requires adequate power-supply decoupling to ensure the output total harmonic distortion (THD) is as low as possible. Power-supply decoupling also prevents oscillations caused by long lead length between the amplifier and the speaker.

Optimum decoupling is achieved by using two different types of capacitors that target different types of noise on the power-supply leads. Higher frequency transients, spikes, or digital hashes should be filtered with a good low equivalent-series-resistance (ESR) ceramic capacitor with a value of typically 1 μ F. This capacitor should be placed as close as possible to the VDD pin of the device. Lower frequency noise signals should be filtered with a large ceramic capacitor of 10 μ F or greater. It is recommended to place this capacitor near the audio power amplifier.

How to Reduce EMI

Most applications require a ferrite bead filter for EMI (electromagnetic interference) elimination, as shown in Figure 1. The ferrite filter reduces EMI around 1MHz and higher. When selecting a ferrite bead, it should be chosen with consideration to high impedance at high frequencies and low impedance at low frequencies.

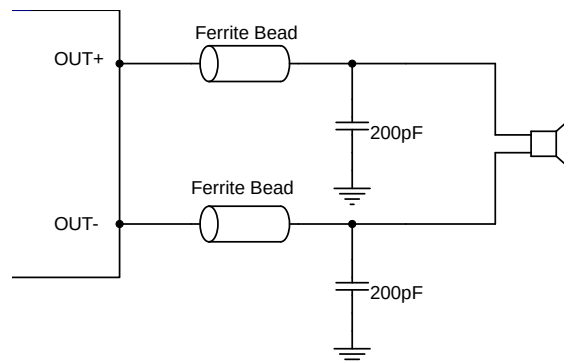


Figure 1. Ferrite Bead Filter to Reduce EMI

Application Information (continued)

Shutdown Operation

The PAM8304 contains amplifier shutdown circuitry in order to reduce power consumption while not in use. When a logic low or ground is applied to the /SD pin, the PAM8304 will enter a standby mode and supply current drawn will be minimized.

Undervoltage Lockout (UVLO)

The PAM8304 incorporates circuitry designed to detect low supply voltage. When the supply voltage drops to 2.5V or below, the PAM8304 goes into a state of shutdown. The device returns to normal operation only when V_{DD} is higher than 2.8V.

Short-Circuit Protection (SCP)

The PAM8304 has short-circuit protection circuitry on the outputs to prevent the device from damage when output-to-output shorts or output-to-GND shorts occur. When a short circuit occurs, the device immediately goes into shutdown state. Once the short is removed the device will be reactivated.

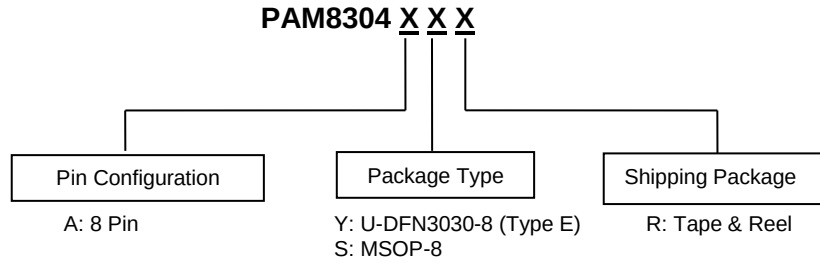
Overtemperature Protection (OTP)

Thermal protection prevents the device from damage. When the internal die temperature exceeds a typical of +150°C, the device will enter a shutdown state and the outputs are disabled. This is not a latched fault, once the thermal fault is cleared and the temperature of the die decreases by 40°C, the device will restart with no external system interaction.

Anti-Pop and Anti-Click Circuitry

The PAM8304 contains circuitry to minimize turn-on and turn-off transients or “click and pops”, where turn-on refers to either power-supply turn-on or device recovery from shutdown mode. When the device is turned on, the amplifiers are internally muted. An internal current source ramps up the internal reference voltage. The device will remain in mute mode until the reference voltage reaches half-supply voltage. As soon as the reference voltage is stable, the device will begin full operation. For the best power-off pop performance, the amplifier should be set in shutdown mode prior to removing the power-supply voltage.

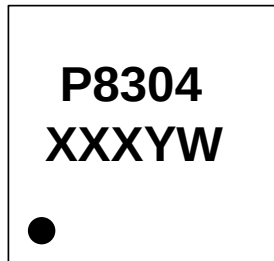
Ordering Information



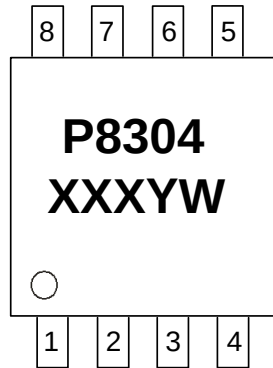
Part Number	Package	Packing	
		Qty.	Carrier
PAM8304AYR	U-DFN3030-8 (Type E)	3000	Tape & Reel
PAM8304ASR	MSOP-8	2500	Tape & Reel

Marking Information

U-DFN3030-8 (Type E)



MSOP-8



P8304: Product Type Marking Code

X : Internal Code

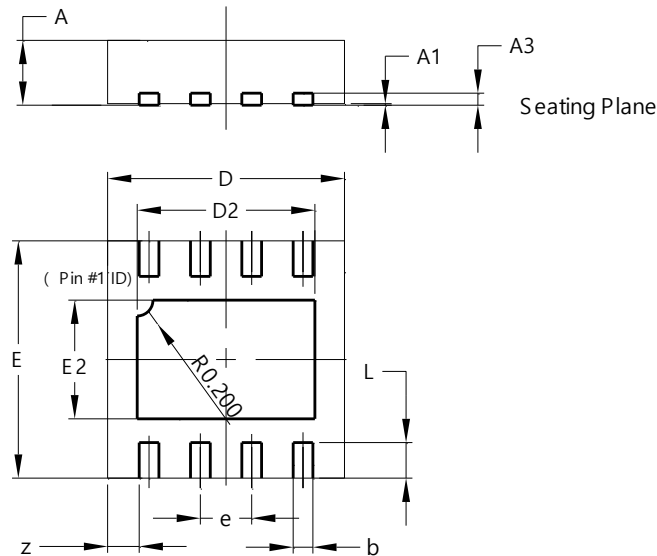
Y : Year : 0 to 9

W : Week : A to Z : 1 to 26 week;
a to z : 27 to 52 week; z represents
52 and 53 week

Package Outline Dimensions

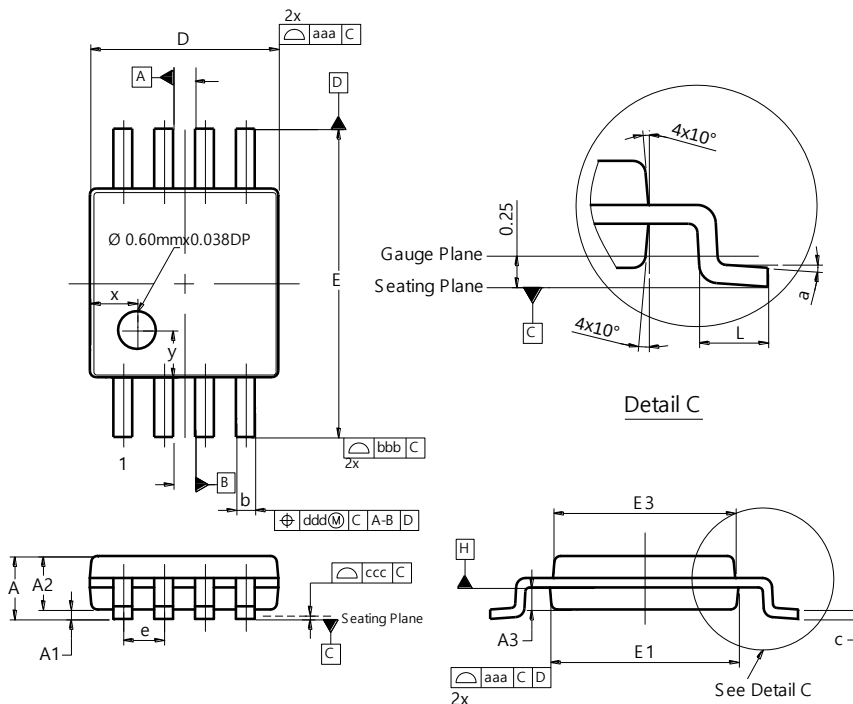
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

U-DFN3030-8 (Type E)



U-DFN3030-8 (Type E)			
Dim	Min	Max	Typ
A	0.57	0.63	0.60
A1	0.00	0.05	0.02
A3	-	-	0.15
b	0.20	0.30	0.25
D	2.95	3.05	3.00
D2	2.15	2.35	2.25
E	2.95	3.05	3.00
E2	1.40	1.60	1.50
e	-	-	0.65
L	0.30	0.60	0.45
z	-	-	0.40
All Dimensions in mm			

MSOP-8

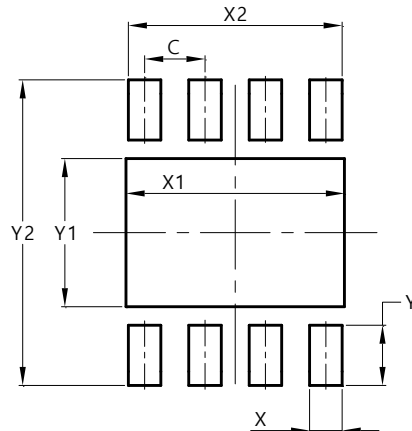


MSOP-8			
Dim	Min	Max	Typ
A	--	1.10	--
A1	0.05	0.15	0.10
A2	0.75	0.95	0.86
A3	0.29	0.49	0.39
b	0.22	0.38	0.30
c	0.08	0.23	0.15
D	2.90	3.10	3.00
E	4.70	5.10	4.90
E1	2.90	3.10	3.00
E3	2.85	3.05	2.95
e	--	--	0.65
L	0.40	0.80	0.60
a	0°	8°	4°
x	--	--	0.750
y	--	--	0.750
aaa	0.20		
bbb	0.25		
ccc	0.10		
ddd	0.13		
All Dimensions in mm			

Suggested Pad Layout

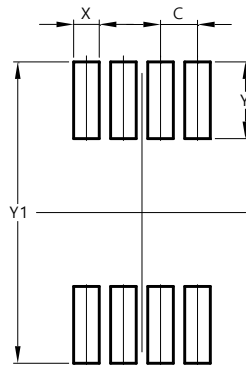
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

U-DFN3030-8 (Type E)



Dimensions	Value (in mm)
C	0.650
X	0.350
X1	2.350
X2	2.300
Y	0.650
Y1	1.600
Y2	3.300

MSOP-8



Dimensions	Value (in mm)
C	0.650
X	0.450
Y	1.350
Y1	5.300

Mechanical Data

U-DFN3030-8 (Type E)

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – NiPdAu, Solderable per J-STD-002, Test B1 (e4)
- Weight: 0.018 grams (Approximate)

MSOP-8

- Moisture Sensitivity: Level 3 per J-STD-020
- Terminals: Finish – Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (e3)
- Weight: 0.027 grams (Approximate)

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